

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
30	0.050 at V <sub>GS</sub> = 10 V	3.4		
	0.085 at V <sub>GS</sub> = 4.5 V	2.6		

#### FEATURES

- Halogen-free Option Available
- TrenchFET<sup>®</sup> Power MOSFET

#### **APPLICATIONS**

• Battery Switch



COMPLIANT

# TO-236 (SOT-23) G 1 S 2 Top View

Si2316DS (C6)\* \* Marking Code

Ordering Information: Si2316DS-T1 Si2316DS-T1-E3 (Lead (Pb)-free) Si2316DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Connect (T. 150 °C) <sup>a b</sup>	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	3.4	2.9	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	T <sub>A</sub> = 70 °C		2.7	2.3	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	16		A
Continuous Source Current (Diode Conduction) <sup>a, b</sup>		۱ <sub>S</sub>	0.8		
	T <sub>A</sub> = 25 °C	P	0.96	0.96 0.7	
Power Dissipation <sup>a, b</sup>	T <sub>A</sub> = 70 °C	- P <sub>D</sub>	0.6	0.45	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 s	R <sub>thJA</sub>	100	130		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	TthJA	140	175	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60	75		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Pulse width limited by maximum junction temperature.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

# Si2316DS

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	Symbol		Limits				
Parameter		Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$				v	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.8			<u> </u>	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V			± 100	nA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	0.5		0.5		
Zero Gate Voltage Drain Current	DSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current <sup>a</sup>		$V_{DS} \ge 4.5$ V, $V_{GS}$ = 10 V	6			- A	
	I <sub>D(on)</sub>	$V_{DS} \ge 4.5$ V, $V_{GS} = 4.5$ V	4				
	P	$V_{GS} = 10$ V, $I_D = 3.4$ A		0.042	0.050	Ω	
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 2.6 \text{ A}$		0.068	0.085		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 4.5 \text{ V}, I_{D} = 3.4 \text{ A}$		6.0		S	
Diode Forward Voltage	V <sub>SD</sub>	$I_{S} = 0.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Dynamic <sup>b</sup>				•			
Total Gate Charge	Qg			4.3	7	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 3.4 A		0.65			
Gate-Drain Charge	Q <sub>gd</sub>			1.2		1	
Input Capacitance	C <sub>iss</sub>			215			
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		90		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			55		1	
Switching	<u> </u>						
Turn-On Delay Time	t <sub>d(on)</sub>			9	15		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		9	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 1.0 A, $V_{GEN}$ = 10 V, $R_G$ = 6 $\Omega$		14	20	- ns	
Fall Time	t <sub>f</sub>			6	12		

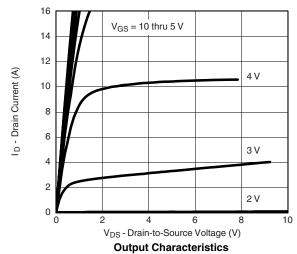
Notes:

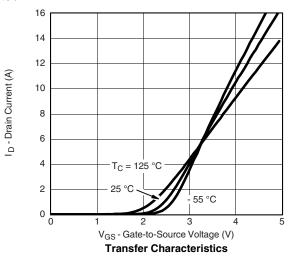
a. Pulse test; PW  $\leq$  300 µs, duty cycle  $\leq$  2 %.

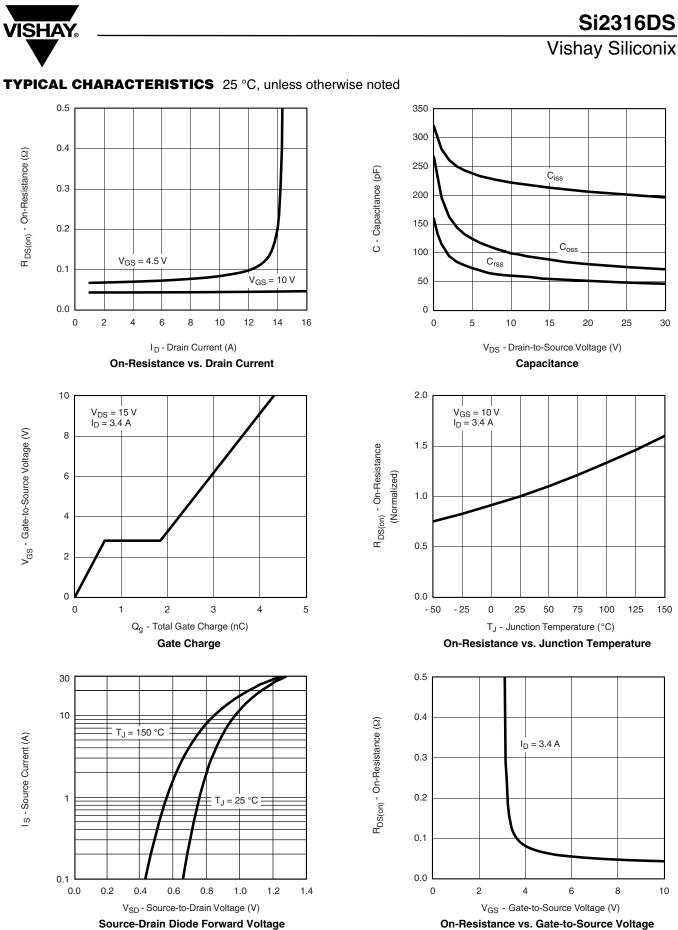
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





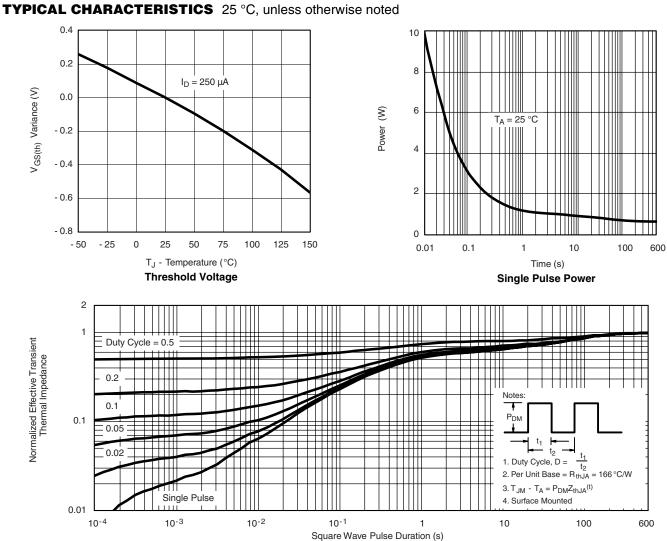


Source-Drain Diode Forward Voltage

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# Si2316DS

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Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71798.





# Package Information

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#### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# Application Note 826

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#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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